18×12 MATRIX LED DRIVER WITH AUTO BREATH

FEATURES

- 18 current sinks, 12 current switches, up to drive 216 LEDs or 72 RGBs.
- Programmable matrix size
- 3 pattern controllers for auto breathing or group PWM control
- Global 256-level DC current configuration
- Individual 256-level PWM for dimming
- Individual 256-level scaling current for colormixing
- High-precision current sinks
 - Device-to-device error: ±5%
 - Channel-to-channel error: ±5%
- EMI and audible noise reduction
 - Phase control
 - Spread spectrum function
 - Programmable slew rate control
- Programmable H/L logic
 - 1.4V/0.4V
 - 2.4V/0.6V
- Individual 216 LEDs open/short detection
- Multiple-device clock synchronization by SYNC pin
- UVLO and over-temperature protection
- De-Ghost
- 1MHz I²C interface, 16 selectable addresses
- Power supply: 2.7V~5.5V
- QFN 5mmx5mmx0.75mm-44L package

APPLICATIONS

Smart speaker, Bluetooth speaker Gaming device (Keyboard, Mouse etc.) Mobile phone, PAD

GENERAL DESCRIPTION

AW20216 is an 18x12 matrix LED driver programmed via an I²C compatible interface. Each channel has individual 8-bit DC current setting for color-mixing and 8-bit PWM current setting for brightness control. The global current of each channel is configured via register GCCR and external resistor R_{EXT} .

Three integrated pattern controllers provide auto breathing or group dimming control. Each pattern controller can work in auto breathing or manual control mode. All breathing parameters are configurable, including rising/falling slope, on/off time, repeat times, and minimum/maximum brightness, etc. Each LED's PWM parameter can be sourced from any one of the 3 pattern controllers optionally.

Phase-delay, phase-inverting, selectable three phase, spread spectrum and slew rate control technology are utilized to reduce EMI and audible noise caused by MLCC when LEDs turn on or off simultaneously.

AW20216 can be turned off with minimum current consumption by either pulling the EN pin low or using the software reset.

AW20216 is available in QFN 5mmx5mmx 0.75mm-44L package. It operates from 2.7V to 5.5V over the temperature range of -40°C to +85°C.

TYPICAL APPLICATION CIRCUIT



	S	W1 SV	V2 SV	V3 S1	N4 SV	V5 SV	V6 SV	/7 SW	/8 SV	/9 SW	10 SV	V11 SW12
RL CS18			*		-	*	*	*	-	*	*	*
R			*				-	*	-	-	-	*
	.ed 🔽	•	*	-	-	-	*	-	, 🔽	*	*	*
•	• •	•	•	•	•	•	•	•	•	•	•	•
	•	•	•	•		•	•	•	•	•	•	•
	-							_				
			*		*	*	*	*	*	*	*	<u>*</u>
			*	*			-	-	-	-	-	*
CS1 —		*	*	* *	-	*	* *	*	*	*	*	
Note1: The R _{LED} =(PVC					d by P\	/CC, \	/F of Ll	ED, ILE	D, VH	R of C	Sx and	1 SWx.

Note2: PVCC and VCC should use same power supply to avoid the additional ISD, such as PVCC=VCC=5V and VIO=3.3V.



PIN CONFIGURATION AND TOP MARK



Figure 2 Pin Configuration and Top Marking



PIN DEFINITION

No.	NAME	DESCRIPTION
1~5	SW10, SW8, SW6, SW4, SW2	Current switches
6	PVCC	Current source power supply, 2.7V~5.5V
7~12	SW1,SW3, SW5,SW7, SW9,SW11	Current switches
13~16	CS18~CS15	Current sink
17	PGND	Power ground
18~22	CS14~CS10	Current sink
23	NC	No connection
24	VCC	Power supply, 2.7V~5.5V
25	NC	No connection
26	GND	Ground
27	AD1	I ² C address select pin1
28	AD0	I ² C address select pin0
29	EN	Standby the chip when EN is low, internally pulled down to GND with a resistor of $1M\Omega$
30	SCL	Serial clock input for I ² C interface
31	SDA	Serial data I/O for I ² C interface
32	ISET	When R_{EXT} =10k Ω , global current of LED is 40mA
33	SYNC	Synchronize pin, used to synchronize clock in multiple devices application, internally pulled down to GND with a resistor of $1M\Omega$
34~38	CS9~CS5	Current sink
39	PGND	Power ground
40~43	CS4~CS1	Current sink
44	SW12	Current switch
45	GND	Thermal pad

FUNCTIONAL BLOCK DIAGRAM





TYPICAL APPLICATION CIRCUIT



SW1 SW2 SW3 SW4 SW5 SW6 SW7 SW8 SW9 SW10 SW11 SW12

CS18 RLED X X X X X X X X X X X X X X X X X X X	
CS17 - RLED X X X X X X X X X X X X X X X X X X X	
CS16 RLED \$\$ \$\$ \$\$ \$\$ \$\$ \$\$ \$\$ \$\$ \$\$ \$\$ \$\$	
• • • • • • • • • • •	•

Note1: The resistance R_{LED} is determined by PVCC, VF of LED, ILED, VHR of CSx and SWx. R_{LED}=(PVCC-VF-VHR_{CS}-VHR_{SW})/I_{MAX}.

Note2: PVCC and VCC should use same power supply to avoid the additional ISD, such as PVCC=VCC=5V and VIO=3.3V.



awinic

AW20216 May. 2023 V1.6







Figure 6 Typical Application Circuit (Eight Parts Synchronization)

ORDERING INFORMATION

Pa	art Number	Temperature	Package	Marking	Moisture Sensitivity Level	Environmental Information	Delivery Form
AW	20216QNR	-40°C~85°C	QFN 5mmX5mm-44L	2R21	MSL3	ROHS+HF	6000 units/ Tape and Reel

ABSOLUTE MAXIMUM RATINGS (NOTE1)

PARAMI	ETERS	RANGE
Supply voltage	e range VCC	-0.3V to 6V
Supply voltage	range PVCC	-0.3V to 6V
Input voltage range	SCL, SDA, EN, AD0, AD1	-0.3V to VCC
Output voltage range	SW1~SW12	-0.3V to PVCC
Oulput voltage range	CS1~CS18	-0.3V to PVCC
Voltage on ISET	ISET	-0.3V to 2V
Junction-to-ambient th	nermal resistance θ _{JA}	33°C/W
Operating free-air to	emperature range	-40°C to 85°C
Maximum operating junc	ction temperature T _{JMAX}	160°C
Storage tempe	erature T _{STG}	-65°C to 150°C
Lead temperature (so	Idering 10 seconds)	260°C
•	ESD (NOTE2)	
HB	Μ	±2kV
CD	M	±1.5kV
	Latch-Up	
Test condition	: JESD78E	±IT: 200mA

NOTE1: Conditions out of those ranges listed in "absolute maximum ratings" may cause permanent damages to the device. In spite of the limits above, functional operation conditions of the device should within the ranges listed in "recommended operating conditions". Exposure to absolute-maximum-rated conditions for prolonged periods may affect device reliability.

NOTE2: The human body model is a 100pF capacitor discharged through a 1.5k Ω resistor into each pin. Test method: MIL-STD-883J Method 3015.9 (HBM). JEDEC EIA/JESD22-C101F (CDM)

Recommended Operating Conditions

Symbol	Parameter	Min.	Тур.	Max.	Unit
VCC	Input voltage	2.7	3.6	5.5	V
PVCC	Input voltage	2.7	5	5.5	V
C ₁ , C ₃	Input capacitance	1	1	22	μF
C ₂ , C ₄ , C ₅	Input capacitance	0.1	0.1	1	μF
R _{EXT}	External resistor for setting sink current	5	10	20	kΩ
T _A	Operating free-air temperature range	-40	25	85	°C

www.awinic.com

ELECTRICAL CHARACTERISTICS

 T_A =25°C, PVCC=VCC=3.6V (unless otherwise noted), R_{EXT}=10k Ω

	PARAMETER	TEST CONDITION	MIN	ТҮР	МАХ	UNIT
Power sup	ply voltage and current					
VCC	Input operating range		2.7		5.5	V
I _{STB_VCC}	Standby current	V _{EN} =0V or CHIPEN = 0		1.3		μA
lact_vcc	Quiescent current in active mode	V _{EN} =VCC,CHIPEN=1, all LEDs off		1.8		mA
Imax	Maximum sink current(CS1~CS18)	V _{LED} =0.5V, GCC= 0xFF, SL= 0xFF	0	40		mA
Vhr	Current switch headroom voltage SWx	Iswitch=720mA, GCC=0xFF, SL=0xFF	3	750		mV
VHR	Current sink headroom voltage CSx	I _{SINK} =40mA, GCC=0xFF, SL= <mark>0xF</mark> F		300		mV
hav	Internal sink current	REXT=0,UVCR.OCPTH=0		75		m۸
ILIM	limit	REXT=0,UVCR.OCPTH=1		120		mA
Іматсн	Device to device current error	All Channels' current set to 40mA	-5		5	%
ΔI_{LED}	Channel to channel current error	All Channels' current set to 40mA	-5		5	%
Fosc	OSC clock frequency		14.88	16	17.12	MHz
T _{SD}	Thermal shutdown threshold			165		°C
ISD	Thermal shutdown hysteresis			25		°C
LOGIC (S	CL,SDA,AD0,AD1,EN)					
VIL	Input logic low	VCC=2.7V~5.5V,LGC=0			0.4	V
VIH	Input logic high	VCC=2.7V~5.5V,LGC=0	1.4			V
VIL	Input logic low	VCC=2.7V~5.5V,LGC=1			0.6	V
VIH	Input logic high	VCC=2.7V~5.5V,LGC=1	2.4			V
Timing						
TSCAN	Period of scanning	PCCR.PWMFRQ[2:0] = 000, GCR.SWSEL[3:0] = 1011		216		μs
T _{DG}	Non-overlap time between SW			1		μs



	PARAMETER	TEST CONDITION	MIN	ТҮР	MAX	UNIT
T _{HOLD}	Delay time between the falling edge of CS18 and SWx			125		ns
TSETUP	Delay time between the rising edge of SWx and CS1	PCCR.PWMFRQ[2:0] = 000		250		ns
TDLY	Delay time of each CS group, there are 6 groups of CS	PCCR.PWMFRQ[2:0] = 000		125		ns

www.awinic.com

I²C INTERFACE TIMING

	DADAMETER	FA	ST MO	DE	FAST	MODE	PLUS	UNIT
	PARAMETER	MIN	ТҮР	MAX	MIN	TYP	MAX	UNIT
Fscl	Interface clock frequency	-		400	-		1000	kHz
THD:STA	(Repeat-start) Start condition hold time	0.6		-	0.26		-	μs
TLOW	Low level width of SCL	1.3		-	0.5	0	-	μs
Тнідн	High level width of SCL	0.6		-	0.26		-	μs
T _{SU:STA}	(Repeat-start) Start condition setup time	0.6		-	0.26		-	μs
THD:DAT	Data hold time	0		-	0		-	μs
T _{SU:DAT}	Data setup time	0.1		ľ	0.05		-	μs
TR	Rising time of SDA and SCL	-		0.3	-		0.12	μs
T _F	Falling time of SDA and SCL	-		0.3	-		0.12	μs
T _{SU:STO}	Stop condition setup time	0.6		-	0.26		-	μs
TBUF	Time between start and stop condition	1.3	-	-	0.5		-	μs



Figure 7 I²C Interface Timing

DETAILED FUNCTIONAL DESCRIPTION

OPERATION MODE AND RESET

POWER ON RESET (POR)

During initial power-up, AW20216 is reset, and all registers are reset to default value, and LED driver is shut down.

Once the supply voltage VCC drops below the threshold voltage V_{POR_VCC} (2.0V), the power-on-reset will be activated to reset the device again. By reading the bit PUST of the register UVCR (page0, address=0x2A), it can be determined whether the device has been reset.

Below is the recommended operation timing:



SOFTWARE RESET

By writing 0xAE to register RSTN (page0, address=0x2F), the software reset is triggered. After software reset, all registers will be reset to the default value and enter into standby mode.

After the software reset command is input through I²C or power on reset, it needs to wait at least 2ms before any other I²C command can be accepted.

STANDBY MODE

When EN is pulled low or the bit CHIPEN of the register GCR (page0, address=0x00) is set to "0" or UVLO is triggered (UVFLG=1) in active mode or OT is active, AW20216 enters into standby mode automatically. In standby mode, all analog blocks are power down but the registers retain the data and keep it available via I²C. When POR is triggered, the device enters into standby mode and all registers will be reset (more information is showed in POWER ON RESET).

ACTIVE MODE

When EN is in high level, and the bit CHIPEN of the register GCR (page0, address=0x00) is set to "1", AW20216 enters into the active mode.

LOW POWER MODE

The bit LPEN of the register MIXCR (page0, address=0x46) is set to "1", the low power mode is enabled. When all PWM[7:0] are 0x00 in active frame, AW20216 automatically enters into low power mode for power saving.

If any bit of PWM[7:0] is not 0 in active frame, the device exits low power mode immediately.



Figure 9 AW20216 Operating Mode Transition

I²C INTERFACE

awinic

AW20216 supports the I²C protocol. The maximum frequency supported by the I²C is 1MHz. The pull-up resistor for the SDA and SCL can be selected from 1k to $10k\Omega$. Usually, $4.7k\Omega$ is recommended for 400 kHz I²C, $1k\Omega$ is recommended for 1MHz I²C. The voltage from 1.8V to 3.3V is allowed for the I²C interface. Additionally, the I²C device supports continuous read and write operations.

DEVICE ADDRESS

The I²C device address is 7-bit (A7~A1), followed by the R/W bit A0 (Read=1/Write=0). Set A0 to "0" for writing and "1" for reading. The values of bits A4:A3 and bits A2:A1 are depended on the connection of pin AD0 and AD1. Separately, there are 4 options: VCC, GND, SCL and SDA. The A7 to A5 is "010" constantly. The device also supports using a broadcast slave address of 0x5A to access registers. All slave addresses as followed.

AD0	AD1	A7:A5	A4:A3	A2:A1	A0	Device Address	Broadcast Address	
GND	GND		00	00		0x20		
GND	VCC		00	01		0x21		
GND	SCL		00	10		0x22		
GND	SDA		00	11		0x23		
VCC	GND	010	01	00	0/1	0x24	0x5A	
VCC	VCC		01	01		0x25		
VCC	SCL		01	10		0x26		
VCC	SDA]	01	11		0x27		
SCL	GND		10	00		0x28		

AD0	AD1	A7:A5	A4:A3	A2:A1	A0	Device Address	Broadcast Address
SCL	VCC		10	01		0x29	
SCL	SCL		10	10		0x2A	
SCL	SDA		10	11		0x2B	
SDA	GND	010	11	00	0/1	0x2C	0x5A
SDA	VCC		11	01		0x2D	
SDA	SCL		11	10		0x2E	
SDA	SDA		11	11		0x2F	

PC START/STOP

I²C start: SDA changes from high level to low level when SCL is high level.I²C stop: SDA changes from low level to high level when SCL is high level.



Figure 10 I²C Start/Stop Condition Timing

DATA VALIDATION

When SCL is high level, SDA level must be constant. SDA can be changed only when SCL is low level.



Figure 11 Data Validation Diagram

ACK (ACKNOWLEDGEMENT)

ACK means the successful transfer of I²C bus data. After master sends an 8-bit data, SDA must be released; SDA is pulled to GND by slave device when slave acknowledges.

When master reads, slave device sends 8-bit data, releases the SDA and waits for ACK from master. If ACK is send and I²C stop is not send by master, slave device sends the next data. If ACK is not send by master, slave device stops to send data and waits for I²C stop.



Figure 12 I²C ACK Timing

WRITE CYCLE

awinic

One data bit is transferred during each clock pulse. Data is sampled during the high state of the serial clock (SCL). Consequently, throughout the clock's high period, the data should remain stable. Any changes on the SDA line during the high state of the SCL and in the middle of a transaction, aborts the current transaction. New data should be sent during the low SCL state. This protocol allows a single data line to transfer both command/control information and data using the synchronous serial clock.

Each data transaction is composed of a start condition, a number of byte transfers (set by the software) and a stop condition to terminate the transaction. Every byte written to the SDA bus must be 8 bits long and is transferred with the most significant bit first. After each byte, an Acknowledge signal must follow.

In a write process, the following steps should be followed:

- a) Master device generates START condition. The "START" signal is generated by lowering the SDA signal while the SCL signal is high.
- b) Master device sends slave address (7-bit) and the data direction bit R/W = 0).
- c) Slave device sends acknowledge signal if the slave address is correct.
- d) Master sends control register address (8-bit).
- e) Slave sends acknowledge signal.
- f) Master sends data byte to be written to the addressed register.
- g) Slave sends acknowledge signal.
- h) If master will send further data bytes the control register address will be incremented by one after acknowledge signal (repeat step f and g).
- i) Master generates STOP condition to indicate write cycle end.



Figure 13 I²C Write Byte Cycle

READ CYCLE

In a read cycle, the following steps should be followed:

- a) Master device generates START condition.
- b) Master device sends slave address (7-bit) and the data direction bit (R/W = 0).
- c) Slave device sends acknowledge signal if the slave address is correct.
- d) Master sends control register address (8-bit).
- e) Slave sends acknowledge signal.
- f) Master generates STOP condition followed with START condition or REPEAT START condition.
- g) Master device sends slave address (7-bit) and the data direction bit (R/W = 1).
- h) Slave device sends acknowledge signal if the slave address is correct.
- i) Slave sends data byte from addressed register.
- j) If the master device sends acknowledge signal, the slave device will increase the control register address by one, then send the next data from the new addressed register.
- k) If the master device generates STOP condition, the read cycle is ended.



Figure 14 I²C Read Byte Cycle

UNDER VOLTAGE LOCK OUT (UVLO)

When bit UVDIS of the register UVCR (page0, address=0x2A) is set to "0", the device monitors the voltage of VCC. If the voltage drops below threshold (2.5V typically), the bit UVFLG of the register UVCR (page0, address=0x2A) will be set to "1". After read-out, the bit UVFLG will be clear.

If both bit UVDIS and bit UVPD of the register UVCR (page0, address=0x2A) are set to "0", UVLO protection function is enabled. Once the event of under voltage occurs, the bit CHIPEN of the register GCR (page0, address=0x00) will be cleared to "0", and then the device will enter into standby mode. If the voltage of VCC rises above the UVLO threshold and then write "1" to bit CHIPEN, the device will enter into active mode again. By default, control bits UVDIS, UVPD are all "0". Both UVLO monitor and protection are enabled.

OVER TEMPERATURE PROTECTION (OTP)

OVER TEMPERATURE ROLL OFF

The bits TRTH[1:0] and bits TROF[1:0] of register OTCR (page0, address=0x27) are thermal roll off threshold temperature and thermal roll off percentage of I_{OUT} respectively. The threshold temperature can be configured as 140°C, 120°C, 100°C or 90°C. Thermal roll off percentage can be configured as 100%, 75%, 50% or 30%. When set the bits TRTH[1:0] to be "00" and set bits TROF[1:0] to be "10", the thermal roll off threshold temperature is "140°C". Once the temperature is over 140°C, the flag bit TRFLG of register OTCR (page0, address=0x27) is set to "1", and I_{OUT} will be decreased to its 75%.

OVER TEMPERATURE ALL LED IS OFF

When bit OTDIS of the register OTCR (page0, address=0x27) is set to "0", the over-temperature detection is enabled. Once the temperature of this device reaches 165°C, the over-temperature condition is detected, and the bit OTFLG of the register OTCR (page0, address=0x27) will be set to "1". The OTFLG will be cleared to "0" after reading the register OTCR.

If both bit OTDIS and bit OTPD of the register OTCR (page0, address=0x27) are set to "0", the Over-Temperature Protection (OTP) function is enabled. Once the temperature is over 165°C, the bit CHIPEN of the register GCR (page0, address=0x00) will be cleared to "0", and then the device will enter into standby mode. When the temperature returns below 140°C, the device will enter into active mode again after writing "1" to bit CHIPEN.

By default, control bits OTDIS and OTPD are all "0", both OT monitor and OT protection are enable.

LED OPEN/SHORT DETECTION

AW20216 supports LED open/short detection. When bits OSDE[1:0] of the register GCR (page0, address=0x00) are set to "11", open detection is enabled, and the detection results can be read out via the registers OSR0~OSR35 (page0, address=0x03~0x26) when CHIPEN is "1". Similarly, when set bits OSDE[1:0] of the register GCR (page0, address=0x00) to "10", short detection is enabled, and the results also can be read out via the registers OSR0~OSR35 when CHIPEN is "1". Each bit of OSR0~OSR35 store a LED's open/short status. Each OSR register stores 6 LEDs open/short status in bit5~bit0. For example, OSR0 stores the status of LED0~LED5, in which MSB is status of LED5, and LSB is status of LED0.

	CS1	CS2	C S 3	CS4	C S5	C S6	CS7	CS8	C S9	CS10	CS11	CS12	CS13	CS14	CS15	CS16	CS17	CS18	
SW1			OS	R0				OSR1					OSR2						
SW2			OS	R3					OS	R4			OSR5						
SW3		OSR6							OS	R7			OSR8						
SW4		OSR9							OSI	R10					OSI	R11			
SW5		OSR12					OSR13					OSR14							
SW6			OSI	R15			OSR16								OSI	R17			
SW7			OSI	R18					OSI	R19			OSR20						
SW8			OSI	R21					OSI	R22					OSI	R23			
SW9			OSI	R24			OSR25						OSR26						
SW10		OSR27					OSR28					OSR29							
SW11		OSR30					OSR31						OSR32						
SW12			osi	R33					OSI	R34					osi	R35			

Figure 15 Open/Short Register

The valid detect result is determined by:

Short detection: V_{cs} > PVCC-VTH_{SHORT}

Open detection: V_{cs} < VTH_{OPEN}

awinic

VTH_{SHORT}: Threshold of short detection (VTH_{SHORT} = 0.8V).

VTH_{OPEN}: Threshold of open detection (VTH_{OPEN} = 0.1V, typical).

The recommend configuration in PVCC=4.2V is:

- PSEL[1:0] = 2'b00, (page0.PCCR[1:0]);
- 0x05 ≤ GCC[7:0] ≤ 0x80, (page0.GCCR);
- 0x20 ≤ PWM[7:0] ≤ 0xFF, (page1.PWMn, n=0~215);
- SL=0xFF, (page2.SLn, n=0~215);

LED DISPLAY AND CONTROL

LED DISPLAY CONTROL DESCRIPTION

The device supports up to 216 LEDs. The location of each LED is shown by the following figure. The parameter location in page1~page3 is the same as the LED.

<u>P\</u>			•	•					•	•		
	⊣Ę́	⊣Ę́	⊣Ę́	⊣Ę́	⊣Ę́	⊣Ę	⊣Ľ	⊣Ľ	⊣Ł	⊣Ę́	⊣Ę́	⊣Ę́
	SW1 SW1	SW2	SW3 SW3	SW4 SW4	SW5 SW5	SW6	SW7	SW8	sw9 sw9	SW10	SW11	SW12
	LED0	LED18	LED36	LED54	LED72	LED90	LED108	LED126	LED144	LED162	LED180	LED198
		LED19	LED37	LED55	LED73	LED91	LED109	LED127	LED145	LED163	LED181	LED199
	LED2	LED20	LED38	LED56	LED <mark>7</mark> 4	LED92	LED110	LED128	LED146	LED164	LED182	LED200
	LED3	LED21	LED39	LED57	LED75	LED93	LED111	LED129	LED147	LED165	LED183	LED201
CS5 -	LED4	LED22	LED40	LED58	LED76	LED94	LED112	LED130	LED148	LED166	LED184	LED202
		LED23	LED41	LE <mark>D</mark> 59	LED77	LED95	LED113	LED131	LED149	LED167	LED185	LED203
	LED6	LED24	LED42	LED60	LED78	LED96	LED114	LED132	LED150	LED168	LED186	LED204
	LED7	LED25	LED43	LED61	LED79	LED97	LED115	LED133	LED151	LED169	LED187	LED205
-OCS9 -		LED26	LED44	LED62	LED80	LED98	LED116	LED134	LED152	LED170	LED188	LED206
	LED9	LED27	LED45	LED63	LED81	LED99	LED117	LED135	LED153	LED171	LED189	LED207
	LED10	LED28	LED46	LED64	LED82	LED100	LED118	LED136	LED154	LED172	LED190	LED208
		LED29	LED47	LED65	LED83	LED101	LED119	LED137	LED155	LED173	LED191	LED209
		LED30	LED48	LED66	LED84	LED102	LED120	LED138	LED156	LED174	LED192	LED210
	LEDIO	LED31	LED49	LED67	LED85	LED103	LED121	LED139	LED157	LED175	LED193	LED211
	LED14	LED32	LED50	LED68	LED86	LED104	LED122	LED140	LED158	LED176	LED194	LED212
	LED15	LED33	LED51	LED69	LED87	LED105	LED123	LED141	LED159	LED177	LED195	LED213
	LED16	LED34	LED52	LED70	LED88	LED106	LED124	LED142	LED160	LED178	LED196	LED214
	LED17	LED35	LED53	LED71	LED89	LED107	LED125	LED143	LED161	LED179	LED197	LED215
Ŧ												

Figure 16 LED Location

In AW20216, each LED is controlled by 4 independent parameters:

- GCC[7:0] control, Global Current Controal, register GCCR (page0, address=0x01);
- PWM[7:0] control, register PWMn (page1, address=0x00~0xD7, n=0~215)
- SL[7:0] control, register SLn (page2, address=0x00~0xD7, n=0~215)
- PAT[1:0] selection, PAT choice, register PATn (page3, address= 0x00~0x47, n=0~215)

User can program above parameters to control each LED. Register PWM can control the brightness of LEDs, register SL can control the constant current and register GCCR can adjust the global current. Via configuring registers PATn (n=0~215), Each LED can be controlled by an internal pattern controller (PAT0, PAT1, PAT2) to dimming synchronously or output the same breathing lighting effect. A group PAT of LEDs controlled by

register PATGn (n=0~71) which contains 3 adjacent LEDs. The figure below shows the LED current control model of AW20216.





The device supports multiple parameters fast updating. The PWM, SL and PAT parameters of each LED are distributed in page1, page2 and page3 respectively. The page4 is virtual page. In page4, PWM and SL parameter of each LED are put together, so it is easy to update both PWM and SL in the order of LED in very short time via one continuous write operation of I²C. The following figure shows the distribution of display parameter in different page.



Figure 18 Display Parameter Distribution in Page1~Page4

awinic

SCANNING TIMING





As shown in scanning timing figure, the SW1~SW11 is turned on by serial, LED is driven by CS1~CS18 within the SWx (x=1~12) active time. T_{DG} is the non-overlap between SW is De-Ghost time. T_{SETUP} is the delay time between the rising edge of SWx and CS1. SW Control 18 channels current sink (CS1~CS18). CS are divided into 6 groups, and each group has a delay time, which is T_{DLY} . T_{PWM} is PWM active time when the register PWMn=0xFF (n=0~215), and T_{HOLD} is the time between the falling edge of CS18 and SWx. In addition, SW scanning number N (N=1~12) can be controlled by bits SWSEL[3:0] in register GCR. N is the sum of 1 and the value of SWSEL[3:0],when the value of SWSEL[3:0] is below 2'b1100. Otherwise N is 12.

When PCCR.PWMFRQ[2:0] = 000 (page0, address=0x29), the DUTY is:

$$DUTY = \frac{15.9375us}{0.25us + 5 \times 0.125us + 16us + 0.125us + 1us} \times \frac{1}{N}$$

Where T_{PWM} = 15.9375us, T_{SETUP}=0.25us, T_{DLY}=0.125us, T_{HOLD}=0.125us, and T_{DG}=1us. The period of PWM is 16us. N is the SW scanning number.

The average output current of LED_n (n=0-215) can be expressed by the following formula,

$$I_{LED} = \frac{K}{R_{EXT}} \times \frac{GCC}{255} \times \frac{SL_n}{255} \times \frac{PWM_n}{255} \times DUTY$$

Where K = 400V, and R_{EXT} is the value of external resistor.

PWM MODULATION

PWM FREQUENCY

The PWM frequency is decided by bits PWMFRQ[2:0] of register PCCR (page0, address=0x29). Following table shows the relationship of PWM frequency and the PWMFRQ[2:0]. To avoid the MLCC audible noise, it's recommended to use the PWM frequency higher than 20 kHz.

PWMFRQ[2:0]	000	001	010	011	100	101	110	111
PWM Freq.	62.5kHz	31.25kHz	15.6kHz	7.8kHz	3.9kHz	1.95kHz	975Hz	488Hz

PWM PHASE CONTROL

To reduce the peak load current and ceramic-capacitor audible ringing, AW20216 supports 6 groups phase

delay, phase inverting and three-phase mode. When the bits PSEL[1:0] in register PCCR (page0, address=0x29) is "00", the 6 group PWM phase-delay scheme is enabled, which means only 3 of 18 LEDs could switch on in the same time. The following figure shows the timing of phase delay mode.



When setting the PSEL[1:0] to "01", the PWM phase of the even-numbered channels is inverted on the basis of phase-delay, as shown figure phase inverting mode. When setting the PSEL[1:0] to "10/11", three-phase mode is enabled, as shown figure three-phase mode. Phase delay, phase inverting and three-phase mode reduce the number of switch-on LEDs at the same time, which is good for reducing the input-current ripple.



Figure 21 Phase Inverting Mode



EMI REDUCTION

awinic

SLEW RATE

AW20216 supports programmed slew rate control, which can change the transition time of the LED current sink (CS1~CS18) on or off, so as to achieve the effect of reducing EMI. The slew rate control is configured by the bits SRR and SRF[1:0] of register SRCR(page0, address=0x2B).



SPREAD SPECTRUM

AW20216 has spread spectrum function to optimize the EMI performance. If bit SSE in register SSCR (page0, address=0x28) is set to "1", spread spectrum function is enabled. By setting the bit SSR in register SSCR (page0, address=0x28), four spread spectrum range 5%, 15%, 25% and 35% can be selected. The total electromagnetic emitting energy can spread into a wider range of frequency band that significantly degrades the peak energy of EMI.

DE-GHOST FUNCTION

To prevent the LED ghost effect, AW20216 has integrated pull down resistors for each SWx ($x=1\sim12$) and pull up resistor for each CSx ($x=1\sim18$). The pull up 8k Ω resistor is disabled when bit PUDIS of register DGCR (page0, address=0x02) is set to "1", and the PUDIS is "0" in default. In addition, SWPDR[2:0] of register DGCR

(page0, address=0x02) can select the SWx pull down resistor. The PDMD of register DGCR (page0, address=0x02) can select the operating mode of de-ghost resistors. When the bit PDMD is "0", the SWx pull down resistor only work at CSx turning-off time. When the bit PDMD is "1", the SWx pull down resistor work all the time.

PATTERN CONTROLLERS

awinic

There is a breathing pattern controller (BPC) in the device, it has three patterns (PAT0~PAT2). Each LED can be configured different patterns by Page3 (PAT choice register), each register can control three LEDs, and each LED have three patterns (00: PWM, 01: PAT0, 10: PAT1, 11: PAT2). Page3 has 72 registers (72x3). PAT0CFG~PAT2CFG (page0, address=0x42~0x44) are PAT0~PAT2 configure registers. When bit PATEN in register PATxCFG (x=0~2) is set to "1", breathing pattern controller is enabled. Pattern controller can be configured as autonomous breathing mode or manual-controlled mode.

AUTONOMOUS BREATHING MODE

When PATEN is set to "1", the pattern controller works in autonomous breathing mode. In this mode, the pattern controller will generate a breathing lighting effect, which is configured by the user-defined timing parameter. The waveform of the breathing lighting effect is shown in the following figure. The parameter T0~T3 define 4 key periods in a complete breathing cycle. T0~T3 composite a breathing loop, denoting the rise-time, on-time, fall-time and off-time respectively. Register PWMxH (x=0~2, page0, address=0x30~0x32) and PWMxL (x=0~2, page0, address=0x33~0x35) control the maximum and minimum brightness of the breathing, respectively. When bit LOGEN in register PATxCFG (x=0~2) is set to "1", the lighting effects switch to logarithmic mode. In the logarithmic mode, the lighting effect is smoother than the linear mode during T0 and T2, and causes the change in intensity to appear more linear to the human eye.



Figure 24 LED Breath Timing in Pattern Mode

The start point and end point of autonomous breathing loop are configurable. The loop starting point could be selected among T0~T3, which is set by bits LB[1:0] in register PATxT2 (x=0-2, page0, address=0x38, 0x3C, 0x40). The end point of the loop can only be selected between the end of T0 and the end of T2, which is determined by bits LE[1:0] in register PATxT2 (x=0-2). The repeat times are determined by the end point defined. If bits LE[1:0] are not "00", the end point of breathing loop is the end of T0, and the loop counter increment by 1 at the end of T0. If bits LE[1:0] are "00", the loop end point is the end of T2, and the loop counter increment by 1 at the end of T2.

The repeat times are decided by bits LT[11:8] in register PATxT2x (x=0~2) and register PATxT3.LT[7:0] (x=0~2, page0, address=0x39, 0x3D, 0x41). When setting LT[11:0] to "0", the breathing pattern will run unlimited times. After the breathing pattern is over, the status bit PATFLG in register PATxCFG (x=0~2) will be set to "1", and PATFLG will be cleared to "1" after reading out through I²C bus. Once breathing loop start again or pattern controller switches to manual mode by setting PATMD bit to "0", the PATFLG will also be cleared.

When bit RUNx in register PATGO ($x=0\sim2$, page0, address=0x45) is set to "1", breathing pattern x is started. The full process of the autonomous breathing is as follows:

- a) Set GCC, SL and PWMxH/L parameter.
- b) Set Page 3 (PAT choice registers) to select the pattern of LEDs.
- c) Configure PATxT0, PATxT1, PATxT2, PATxT3 (x=0~2) to control the breath time, start/stop point, and repeat times.
- d) Set PATEN=1 to enable breathing pattern mode.
- e) Set PATMD=1 and RAMPE=1 to select auto breathing mode and enable breathing ramp (x=0~2).
- f) Set LOGEN to select the breathing in log curve mode or linear mode ($x=0\sim2$).
- g) Set RUNx=1 to start the breath pattern x (x=0~2).

MANUAL CONTROL MODE

awinic

If bit PATMD is set to "0", manual control mode is selected. In manual control mode, user could set the bit SWITCH of register PATxCFG (x=0~2) to control the output of pattern controller. When SWITCH is "1", the output of pattern controller is decided by register PWMxH (x=0~2). When bit SWITCH is set to "0", the output is the decided by register PWMxL (x=0~2).

If bit RAMPE in register PATxCFG (x=0~2) is set to "1", the smooth ramp up/down will be enabled. At the same time, if SWITCH changes from "0" to "1", the output will be ramp up to PWMxH (x=0~2) smoothly. Similarly, if SWITCH changes from "1" to "0", the output of the pattern controller will ramp down to PWMxL (x=0~2) smoothly. It's also support the logarithmic mode ramp.

However, if RAMPE is set to "0", the output of the pattern controller will change to PWMxH or PWMxL(x=0~2) directly with no ramp as the SWITCH changes.



MULTIPLE DEVICE SYNCHRONIZATION

AW20216 supports multiple device synchronization to drive more than 216 LEDs by cascade of multiple devices. In this application, all devices share a common clock, one device works as a master to output common clock on pin SYNC, and other devices work as slave to use external input clock from pin SYNC. Bit CLKOE and CLKSEL in Register SSCR (page0, address=0x28) select the clock input or output on pin SYNC.

CLKOE	CLKSEL	Device Clock Selection
0	0	Use Internal clock and pin SYNC is high-Z
1	0	Master, use internal clock and output it on pin SYNC
0	1	Slave, use external clock from pin SYNC
1	1	Forbidden

REGISTER CONFIGURATION

REGISTER CONTROL

awinic



Figure 26 Register Control

Page register (address=0xF0) can select page from page0 to page4. User can choose page0~page4 by writing 0xC0~0xC4 to the page register in any page. The page0 is activated by default. The page4 is a virtual page that can configure PWM and SL in the same time, and the address auto-increases by one after the PWM and SL data are written. The page4 only supports writing, and is available when register MIXCR.PAGE4EN (page0, address=0x46) is set to "1".

REGISTER LIST

-		-									
ADDR	NAME	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Default
0x00	GCR	R/W		SW	'SEL		LGC	OSE	DE	CHIPEN	0xB0
0x01	GCCR	R/W		GCC						0x00	
0x02	DGCR	R/W	PUDIS	PUDIS - PDMD SWPDR						0x44	
0x03 ~ 0x26	OSR0 ~ OSR35	R		- LED0~LED215 Open/Short status register						0x00	
0x27	OTCR	R/W	OTFLG	OTPD	OTPD OTDIS TRFLG TRTH TROF					0x00	
0x28	SSCR	R/W	CLKOE	CLKSEL	CLKSEL - SSE SRR				С	CLT	
0x29	PCCR	R/W		PWMFRQ			-		PS	SEL	0x00
0x2A	UVCR	R/W	REX	T_ST	OCPTH	OCPD	PUST	UVFLG	UVPD	UVDIS	0x00
0x2B	SRCR	R/W		-	ОТН	-	-	SRR	S	RF	0x02
0x2F	RSTN	R/W				RS	ΓN/ID				0x70
0x30	PWMH0	R/W				PW	MH0				0x00
0x31	PWMH1	R/W		PWMH1						0x00	
0x32	PWMH2	R/W		PWMH2						0x00	
0x33	PWML0	R/W		PWML0							0x00
0x34	PWML1	R/W		PWML1							0x00

Page0: Function Register List

ADDR	NAME	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Default	
0x35	PWML2	R/W				PW	/ML2				0x00	
0x36	PAT0T0	R/W		٦	ГО				0x00			
0x37	PAT0T1	R/W		٦	Г2			T	3		0x00	
0x38	PAT0T2	R/W	l	E	L	В		LT[1	1:8]		0x00	
0x39	PAT0T3	R/W				LT	[7:0]				0x00	
0x3A	PAT1T0	R/W		٦	ГО			Τ́			0x00	
0x3B	PAT1T1	R/W		٦	Г2			T:	3		0x00	
0x3C	PAT1T2	R/W	l	_E	L	В		LT[1	1:8]		0x00	
0x3D	PAT1T3	R/W				LT	[7:0]	7:0]				
0x3E	PAT2T0	R/W		٦	ГО			T'			0x00	
0x3F	PAT2T1	R/W		٦	Г2			T	3		0x00	
0x40	PAT2T2	R/W	l	_E	L	В		LT[1	LT[11:8]			
0x41	PAT2T3	R/W				LT	[7:0]	0x00				
0x42	PAT0CFG	R/W		-	PATFLG	LOGEN	SWITH	RAMPE	PATMD	PATEN	0x00	
0x43	PAT1CFG	R/W		-	PATFLG	LOGEN	SWITH	RAMPE	PATMD	PATEN	0x00	
0x44	PAT2CFG	R/W		-	PATFLG	LOGEN	SWITH	RAMPE	PATMD	PATEN	0x00	
0x45	PATGO	R/W	-	PAT2ST	PAT1ST	PATOST	-	RUN2	RUN1	RUN0	0x00	
0x46	MIXCR	R/W						PAGE4EN	LPEN	BCDIS	0x02	
0x4D	SDCR	R/W	SDCR						0x00			
0xF0	PAGE	R/W	- PAGE						0x00			

Page1: PWM Register List

ADDR	NAME	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Default
0x00	PWM0	R/W		PWMO							
0x01	PWM1	R/W		PWM1							
		R/W									0x00
0xD7	PWM215	R/W		PWM215							0x00
0xF0	PAGE	R/W			-				PAGE		0x00

Page2: SL Register List

ADDR	NAME	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Default
0x00	SL0	R/W		SLO							
0x01	SL1	R/W		SL1							
		R/W									
0xD7	SL215	R/W		SL215							0x00
0xF0	PAGE	R/W		- PAGE							0x00

Page3: PAT Choice Register List

ADDR	NAME	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Default
0x00	PATG0	R/W	-		PA	PAT2		PAT1		PAT0	
0x01	PATG1	R/W		-	PA	\T5	PAT4		PAT3		0x00
		R/W		-							0x00
0x47	PATG71	R/W		-	PAT	PAT215		PAT214		T213	0x00
0xF0	PAGE	R/W			-				PAGE		0x00

Page4: PWMx+SLx Register List

ADDR	NAME	R/W	Bit15	Bit14		Bit8	Bit7	Bit6		Bit0	Default
0x00	PWM0+ SL0	W		PW	MO			S	LO		0x00
0x01	PWM1+ SL1	W		PW	M1				0x00		
		W							0x00		
0xD7	PWM215+ SL215	W		PWM	1215				0x00		
0xF0	PAGE	W							PA	AGE	0x00

REGISTER DETAILED DESCRIPTION

GCR: Global Control Register (Page 0: Address 0x00)

Bit	Symbol	R/W	Description	Default
7:4	SWSEL	R/W	Active the SW number select 0000: SW1 active SW2~SW12 not active 0001: SW1~SW2 active SW3~SW12 not active 0010: SW1~SW3 active SW4~SW12 not active 0011: SW1~SW4 active SW5~SW12 not active 0100: SW1~SW5 active SW6~SW12 not active 0101: SW1~SW6 active SW7~SW12 not active 0110: SW1~SW7 active SW8~SW12 not active 0111: SW1~SW8 active SW9~SW12 not active 1000: SW1~SW9 active SW10~SW12 not active 1001: SW1~SW10 active SW11~SW12 not active 1010: SW1~SW11 active SW12 not active 1011~1111: SW1~SW12 active	1011
3	LGC	R/W	Logic level select 0: 1.4/0.4V 1: 2.4/0.6V	0
2:1	OSDE	R/W	Open/short detect enable 0x: Detect disable 10: Short detect 11: Open detect	00
0	CHIPEN	R/W	Chip enable 0: Disable 1: Enable	0

GCCR: Global Current Control Register (Page 0: Address 0x01)

Bit	Symbol	R/W	Description	Default
7:0	GCC	R/W	Global current control	0x00

DGCR: De-ghost Control Register (Page 0: Address 0x02)

DGCR:	De-ghost Control	Regist	er (Page 0: Address 0x02)	
Bit	Symbol	R/W	Description	Default
7	PUDIS	R/W	8kΩ CSx pull up resistance disable (x=1~18): 0: Enable all the time 1: Disable	0
6:4	RESERVED	R	Reserved	100
3	PDMD	R/W	Pull down mode select 0: Only in SWx off time (x=1~12) 1: All the time	0
2:0	SWPDR	R/W	SW pull down resistance select 000: Disable pull down resistance 001: $0.25k\Omega$ 010: $0.5k\Omega$ 011: $1 k\Omega$ 100: $2 k\Omega$ 101: $4 k\Omega$ 110: $8 k\Omega$ 111: $16 k\Omega$	100

OSR0~OSR35: Open/Short Status Register (Page 0: Address 0x03~0x26)

Bit	Symbol	R/W	Description	Default
7:6	RESERVED	R	Reserved	00
5:0	OSR	R	Open/short status of LED0~LED215 0: Open/short not happen 1: Open/short happen	000000

OTCR: Over Temperature Control Register (Page 0: Address 0x27)

Bit	Symbol	R/W	Description	Default
7	OTFLG	R	Over temperature flag 0: Over-temperature not happen 1: Over-temperature happen	0
6	OTPD	R/W	Over-temperature(OT) protect disable 0: OT protect enable, when OT event occurs, device will clear GCR.CHIPEN to 0. 1: OT protect disable	0
5	OTDIS	R/W	Over-temperature detect disable 0: OT detect enable, when OT event occurs, OTCR.OTFLAG will be set. 1: OT detect disable	0
4	TRFLG	R	Thermal roll off status 0: Roll off not happen 1: Roll off happen	0
3:2	TRTH	R/W	Thermal roll threshold 00: 140°C 01: 120°C 10: 100°C 11: 90°C	00
1:0	TROF	R/W	Thermal roll off percentage of IouT 00: 100% 01: 75% 10: 55% 11: 30%	00

SSCR: Spread Spectrum Control Register (Page 0: Address 0x28)

Bit	Symbol	R/W	Description	Default
7	CLKOE	R/W	Clock output enable 0: Disable 1: Enable	0
6	CLKSEL	R/W	0: Use internal 16MHz OSC clock 1: Use clock input from pin SYNC	0
5	RESERVED	R	Reserved	0
4	SSE	R/W	Spread spectrum enable 0: Disable 1: Enable	0
3:2	SSR	R/W	Spread spectrum range 00: ±5% 01: ±15% 10: ±25% 11: ±35%	00



AW20216

May. 2023 V1.6

Bit	Symbol	R/W	Description	Default
1:0	CLT	R/W	Spread spectrum cycle time 00: 1980µs 01: 1200µs 10: 820µs 11: 660µs	00

PCCR: PWM Clock Control Register (Page 0: Address 0x29)

Bit	Symbol	R/W	Description	Default
7:5	PWMFRQ	R/W	PWM frequency selection 000: 62.5kHz 001: 32.25kHz 010: 15.6kHz 011: 7.8kHz 100: 3.9kHz 101: 1.95kHz 110: 977Hz 111: 488Hz	000
4:2	RESERVED	R	Reserved	000
1:0	PSEL	R/W	PWM phase selection 00: Phase delay mode 01: Phase inverting mode 1x: Three-phase mode	00

UVCR: UVLO Control Register (Page 0: Address 0x2A)

Bit	Symbol	R/W	Description	Default
7:6	REXT_ST	R	R _{EXT} status 00: Normal 10: R _{EXT} is open 01: R _{EXT} is short or OCP 11: Not defined	00
5	ОСРТН	R/W	OCP threshold 0: 75mA 1: 120mA	0
4	OCPD	R/W	OCP disable 0: Enable OCP 1: Disable OCP	0
3	PUST	R	Power-up reset status 0: Power-up reset not happen 1: Power-up reset happen	0

AW20216

May. 2023 V1.6	6
----------------	---

Bit	Symbol	R/W	Description	Default
2	UVFLG	R	UVLO status 0: UVLO not happen 1: UVLO happen	0
1	UVPD	R/W	 UVLO protect disable 0: UVLO protect enable, when under-voltage event occurs, device will clear GCR.CHIPEN to 0. 1: UVLO protect disable 	0
0	UVDIS	R/W	 UVLO detect disable 0: UVLO detect enable, when under-voltage event occurs, UVCR.UVFLG will be set. 1: UVLO detect disable 	0

SRCR: Open/Short Control Register (Page 0: Address 0x2B)

Bit	Symbol	R/W	Description	Default
7:6	RESERVED	R	Reserved	00
5	ОТН	R/W	Open threshold 0: 0.1V 1: 0.2V	0
4	RESERVED	R	Reserved	0
3	RESERVED	R	Reserved	0
2	SRR	R/W	Slew rate control for LED output rising time 0: 1ns 1: 6ns	0
1:0	SRF	R/W	Slew rate control for LED output falling time 00: 1ns 01: 3ns 10: 6ns 11:10ns	10

RSTN: Reset Register (Page 0: Address 0x2F)

Bit	Symbol	R/W	Description	Default
7:0	RSTN	R/W	Write 0xAE to the register will reset all registers to their default value. The chip ID will be read out from the register.	0x70

PWMH0~PWMH2: Maximum Brightness for Auto Breath (Page 0: Address 0x30~0x32)

Bit	Symbol	R/W	Description	Default
7:0	PWMH	R/W	Maximum brightness configure for auto breath.	0x00

PWML0~PWML2: Minimum Brightness for Auto Breath (Page 0: Address 0x33~0x35)

Bit	Symbol	R/W	Description	Default
7:0	PWML	R/W	Minimum brightness configure for auto breath.	0x00

PAT0T0~PAT2T0: Pattern Timer 0 (Page 0: Address 0x36 0x3A 0x3E)

Bit	Symbol	R/W		Descr	ription		Default
7:4	то	R/W	Ramp rise time T0 0000 0001 0010 0011 0100 0101 0110		T0 1000 1001 1010 1011 1100 1101 1110	Time 2.1s 2.6s 3.1s 4.2s 5.2s 6.2s 7.3s	0000
			0111	1.6s	1111	8.3s	
3:0	T1	R/W	Hold on time T1 0000 0001 0010 0011 0100 0101 0110 0111	Time 0.04s 0.13s 0.26s 0.38s 0.51s 0.77s 1.04s 1.6s	T1 1000 1001 1010 1011 1100 1101 1110 1111	Time 2.1s 2.6s 3.1s 4.2s 5.2s 6.2s 7.3s 8.3s	0000

Bit	Symbol	R/W		Descr	iption		Default
			Ramp fall time				
			T2	Time	T2	Time	
			0000	0s	1000	2.1s	
			0001	0.13s	1001	2.6s	
7:4	Т2	R/W	0010	0.26s	1010	3.1s	0000
7.4	12		0011	0.38s	1011 🔶	4.2s	0000
			0100	0.51s	1100	5.2s	
			0101	0.77s	1101	6.2s	
			0110	1.04s	1110	7.3s	
			0111	1.6s	1111	8.3s	
			Hold off time				
			Т3	Time	ТЗ	Time	
			0000	0.04s	1000	2.1s	
			0001	0.13s	1001	2.6s	
	TO	DAA	0010	0.26s	1010	3.1s	0000
3:0	Т3	R/W	0011	0.38s	1011	4.2s	0000
			0100	0.51s	1100	5.2s	
			0101	0.77s	1101	6.2s	
			0110	1.04s	1110	7.3s	
			0111	1.6s	1111	8.3s	

PAT0T1~PAT2T1: Pattern Timer 1 (Page 0: Address 0x37 0x3B 0x3F)

PAT0T2~PAT2T2: Pattern Control Register 1 (Page 0: Address 0x38 0x3C 0x40)

Bit	Symbol	R/W	Description	Default
7:6	LE	R/W	End point of the auto-breath loop pattern 00: Pattern finally stop at OFF state Other: Pattern finally stop at ON state	00
5:4	LB	R/W	Start point of the auto-breath loop pattern 00: Pattern start from RISE state 01: Pattern start from ON state 10: Pattern start from FALL state 11: Pattern start from OFF state	00
3:0	LT[11:8]	R/W	4 MSB of auto-breath loop times	0000

PAT0T3~PAT2T3: Pattern Control Register 2 (Page 0: Address 0x39 0x3D 0x41)

Bit	Symbol	R/W	Description	Default
7:0	LT[7:0]	R/W	8 LSB of auto-breath loop times Note: when LT[11:0]=0, the pattern will run forever. In this case, you can switch auto-breath mode to manual mode and then turn the pattern off.	0x00

PAT0CFG~PAT2CFG: Configure Register (Page 0: Address 0x42~0x44)

Bit	Symbol	R/W	Description	Default
7:6	RESERVED	R	Reserved	00
5	PATFLG	R	Auto breath pattern loop end flag 0: Loop is not over 1: Loop is over	0
4	LOGEN	R/W	Log curve output enable 0: Disable 1: Enable	0
3	SWITCH	R/W	Switch on or off at manual mode. 0: LED off 1: LED on	0
2	RAMPE	R/W	PAT ramp enable 0: Ramp disable 1: Ramp enable	0
1	PATMD	R/W	Breath pattern control mode selection 0: Manual mode 1: Auto breath pattern mode	0
0	PATEN	R/W	Auto breath pattern controller enable 0: Disable 1: Enable	0

PATGO: Start Control Register (Page 0: Address 0x45)

Bit	Symbol	R/W	Description	Default
7	RESERVED	R	Reserved	0
6	PAT2ST	R	Auto breath pattern 2 status 0: Pattern is stop 1: Pattern is running	0
5	PAT1ST	R	Auto breath pattern 1 status 0: Pattern is stop 1: Pattern is running	0



Bit	Symbol	R/W	Description	Default
4	PAT0ST	R	Auto breath pattern 0 status 0: Pattern is stop 1: Pattern is running	0
3	RESERVED	R	Reserved	0
2	RUN2	R/W	Auto breath pattern 2 run control Write "1" to run auto breath pattern Note: You shall write "0" and then write "1" to this bit to restart a new auto breath pattern.	0
1	RUN1	R/W	Auto breath pattern 1 run control Write "1" to run auto breath pattern Note: You shall write "0" and then write "1" to this bit to restart a new auto breath pattern.	0
0	RUN0	R/W	Auto breath pattern 0 run control Write "1" to run auto breath pattern Note: You shall write "0" and then write "1" to this bit to restart a new auto breath pattern.	0

MIXCR: Mix Function Control Register (Page 0: Address 0x46)

Bit	Symbol	R/W	Description	Default
7:3	RESERVED	R	Reserved	00000
2	PAGE4EN	R/W	Page 4 enable 0: Disable 1: Enable	0
1	LPEN	R/W	Low-power mode enable 0: Disable 1: Enable	1
0	BCDIS	R/W	Broadcast disable 0: Enable 1: Disable	0

SDCR: SW Drive Capability Register (Page 0: Address 0x4D)

Bit	Symbol	R/W	Description	n	Default
7:3	RESERVED	R	Reserved		00000
2:0	SDCR	R/W	001: 1.08A 1 010: 1.19A 1	00: 1.61A 01: 1.72A 10: 1.85A 11: 2.00A	000

PWMx (x=0~215): PWM Configure Register (Page 1: Address 0x00~0xD7)

Bit	Symbol	R/W	Description	Default
7:0	PWMx	R/W	PWM modulated	0x00

SLx (x=0~215): SL Configure Register (Page 2: Address 0x00~0xD7)

Bit	Symbol	R/W	Description	+ 1/7	Default
7:0	SLx	R/W	Control the constant current	7	0x00

PATGx (x=0~71): PAT Choice Register (Page 3: Address 0x00~0x47)

Bit	Symbol	R/W	Description	Default
7:6	RESERVED	R	Reserved	00
5:4	PAT3x+2	R/W	Control the patterns of LED 3x+2: 00: PWM parameter comes from PWM register 01: PWM parameter comes from pattern controller 0 10: PWM parameter comes from pattern controller 1 11: PWM parameter comes from pattern controller 2	00
3:2	PAT3x+1	R/W	Control the patterns of LED 3x+1: 00: PWM parameter comes from PWM register 01: PWM parameter comes from pattern controller 0 10: PWM parameter comes from pattern controller 1 11: PWM parameter comes from pattern controller 2	00
1:0	PAT3x	R/W	Control the patterns of LED 3x: 00: PWM parameter comes from PWM register 01: PWM parameter comes from pattern controller 0 10: PWM parameter comes from pattern controller 1 11: PWM parameter comes from pattern controller 2	00

PWMx+SLx (x=0~215): PWM and SL Configure Register (Page 4: Address 0x00~0xD7)

Bit	Symbol	R/W	Description	Default
15:8	PWMx	W	PWM modulated	0x00
7:0	SLx	W	Control the constant current	0x00

APPLICATION INFORMATION

PVCC and VCC should use same power supply to avoid the additional ISD, such as PVCC=VCC=5V and VIO=3.3V.

If the equipment has antenna, the IC should be far away from the antenna in order to avoid the EMI.

Rext

The selection of R_{EXT} determined the maximum LED0~LED215 current I_{MAX} as described in below formula (1).

$$I_{MAX} = \frac{K}{R_{EXT}}$$
(1)

When $R_{EXT} = 10K\Omega$, $I_{MAX} = 40mA$, $I_{SWITCH} = 720mA$, SDCR[2:0] = 000 (page0, address = 0x4D) When $R_{EXT} = 5K\Omega$, $I_{MAX} = 80mA$, $I_{SWITCH} = 1.44A$, SDCR[2:0] = 111 (page0, address = 0x4D).

PCB LAYOUT CONSIDERATION

AW20216 is an 18x12 matrix LED driver programmed via an I²C compatible interface. When all LEDs are operating, the device power dissipation is large. To obtain the good thermal performance and avoid thermal shutdown, PCB layout should be considered carefully. Here are some guidelines:

- 1. The C_1 , C_2 , C_3 , C_4 , C_5 should be placed as close to the chip as possible.
- 2. The R_{EXT} should be placed as close to the chip as possible.
- 3. The Thermal PAD must be well connecting to the GND of the PCB, and add as many thermal via as possible beneath the thermal PAD on the PCB for the heat conductivity of the device and PCB.

TAPE AND REEL INFORMATION



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



DIMENSIONS AND PIN1 ORIENTATION

D1	D0	A0	B0	K0	P0	P1	P2	W	Pin1 Quadrant
(mm)									
330	12.4	5.3	5.3	1.1	2	8	4	12	Q1

All dimensions are nominal



PACKAGE DESCRIPTION





LAND PATTERN DATA



REVISION HISTORY

Version	Date	Change Record	
V1.0	Apr. 2020	Officially released	
V1.1	Jun. 2020	Add the EMI reduction description Modify the CHIP ID Add optional SW drive capability register description Add application information description	page21 page24 page34 page36
V1.2	Oct. 2020	Add the Notes in application	page36
V1.3	Feb. 2022	Modify the application circuit	page2
V1.4	Nov. 2022	Corrected the formula of the DUTY	page19
V1.5	Dec. 2022	Update the description of De-Ghost Function Modify the Register Description	page21 page 27,30
V1.6	May. 2023	Corrected Typical Application Circuits Corrected Recommended Operating Conditions Corrected the default value of bit LPEN of register MIXCR(0x46) Corrected the description of bit OCPTH of register UVCR(0x2A) Corrected the formula of the DUTY	page2,4&5 page7 page25&34 page29 page19

DISCLAIMER

All trademarks are the property of their respective owners. Information in this document is believed to be accurate and reliable. However, Shanghai AWINIC Technology Co., Ltd (AWINIC Technology) does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

AWINIC Technology reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. Customers shall obtain the latest relevant information before placing orders and shall verify that such information is current and complete. This document supersedes and replaces all information supplied prior to the publication hereof.

AWINIC Technology products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an AWINIC Technology product can reasonably be expected to result in personal injury, death or severe property or environmental damage. AWINIC Technology accepts no liability for inclusion and/or use of AWINIC Technology products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications that are described herein for any of these products are for illustrative purposes only. AWINIC Technology makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

All products are sold subject to the general terms and conditions of commercial sale supplied at the time of order acknowledgement.

Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Reproduction of AWINIC information in AWINIC data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. AWINIC is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of AWINIC components or services with statements different from or beyond the parameters stated by AWINIC for that component or service voids all express and any implied warranties for the associated AWINIC component or service and is an unfair and deceptive business practice. AWINIC is not responsible or liable for any such statements.